



ASSEMBLY NOTES:

- Built on PMP30313 Rev_A PCB
- Reference designators > 99 have been added on PCB
- "DNP" = "Do not populate"
- Adapt T1 to PCB pattern, due to different footprint length

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		TID #:	Project Title: 85VAC-264VAC PSR Isolated Flyback	
		Number: PMP30313	Rev: B	Sheet Title: 85VAC-264VAC PSR Isolated Flyback
		Rev: Version control disabled	Assembly Variant: No Variations	Sheet: 1 of 1
		Drawn By: R. Scibilia	File: PMP30313 Rev_B Schematic.SchDoc	Size: B
		Engineer: R. Scibilia	Contact: http://www.ti.com/support	http://www.ti.com



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